# 74AVCH2T45

Dual-bit, dual-supply voltage level translator/transceiver; 3-state

Rev. 9 — 25 June 2024

**Product data sheet** 

### 1. General description

The 74AVCH2T45 is a dual bit, dual supply transceiver that enables bidirectional level translation. It features two data input-output ports (nA and nB), a direction control input (DIR) and dual supply pins ( $V_{CC(A)}$  and  $V_{CC(B)}$ ). Both  $V_{CC(A)}$  and  $V_{CC(B)}$  can be supplied at any voltage between 0.8 V and 3.6 V making the device suitable for translating between any of the low voltage nodes (0.8 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V). Pins nA and DIR are referenced to  $V_{CC(A)}$  and pins nB are referenced to  $V_{CC(B)}$ . A HIGH on DIR allows transmission from nA to nB and a LOW on DIR allows transmission from nB to nA.

The device is fully specified for partial power-down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either  $V_{CC(A)}$  or  $V_{CC(B)}$  are at GND level, both A and B are in the high-impedance OFF-state.

The 74AVCH2T45 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

### 2. Features and benefits

- Wide supply voltage range: 0.8 V to 3.6 V for V<sub>CC(A)</sub> and V<sub>CC(B)</sub>
- High noise immunity
- Suspend mode
- Bus hold on data inputs
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V<sub>CC</sub>
- IOFF circuitry provides partial Power-down mode operation
- Maximum data rates:
  - 500 Mbps (1.8 V to 3.3 V translation)
  - 320 Mbps (< 1.8 V to 3.3 V translation)</li>
  - 320 Mbps (translate to 2.5 V or 1.8 V)
  - 280 Mbps (translate to 1.5 V)
  - 240 Mbps (translate to 1.2 V)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 3B exceeds 8000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

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# 3. Ordering information

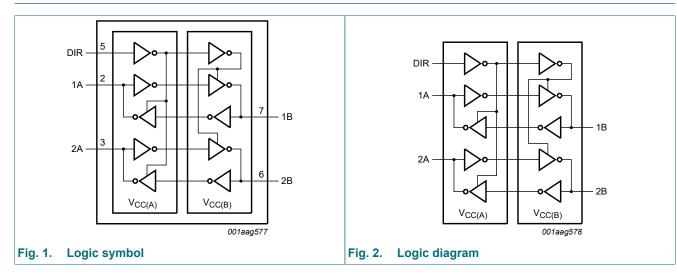
Table 1. Ordering i	nformation									
Type number	Package									
	Temperature range	Name	Description	Version						
74AVCH2T45DC	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	<u>SOT765-1</u>						
74AVCH2T45GT	-40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm	<u>SOT833-1</u>						
74AVCH2T45GN	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.2 × 1.0 × 0.35 mm	<u>SOT1116</u>						
74AVCH2T45GS	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.0 × 0.35 mm	<u>SOT1203</u>						

### 4. Marking

Table 2. Marking	
Type number	Marking code [1]
74AVCH2T45DC	К45
74AVCH2T45GT	К45
74AVCH2T45GN	К5
74AVCH2T45GS	К5

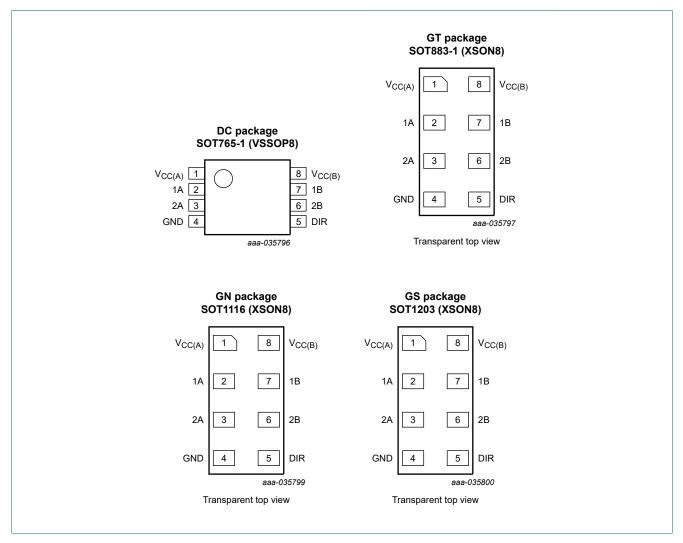
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

# 5. Functional diagram



## 6. Pinning information





### 6.2. Pin description

Table 3. Pin description		
Symbol	Pin	Description
V <sub>CC(A)</sub>	1	supply voltage port A and DIR
1A	2	data input or output
2A	3	data input or output
GND	4	ground (0 V)
DIR	5	direction control
2B	6	data input or output
1B	7	data input or output
V <sub>CC(B)</sub>	8	supply voltage port B

### 7. Functional description

#### Table 4. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Supply voltage	Input	Input/output[1]				
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	DIR[2]	nA	nB			
0.8 V to 3.6 V	L	nA = nB	input			
0.8 V to 3.6 V	Н	input	nB = nA			
GND[3]	Х	Z	Z			

[1] The input circuit of the data I/O is always active.

[2] The DIR input circuit is referenced to  $V_{CC(A)}$ .

[3] If at least one of  $V_{CC(A)}$  or  $V_{CC(B)}$  is at GND level, the device goes into suspend mode.

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC(A)</sub>	supply voltage A			-0.5	+4.6	V
V <sub>CC(B)</sub>	supply voltage B			-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+4.6	V
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V		-50	-	mA
Vo	output voltage	Active mode	[1][2][3]	-0.5	V <sub>CCO</sub> + 0.5	V
		Suspend or 3-state mode	[1]	-0.5	+4.6	V
I <sub>O</sub>	output current	$V_{O} = 0 V \text{ to } V_{CCO}$		-	±50	mA
I <sub>CC</sub>	supply current	I <sub>CC(A)</sub> or I <sub>CC(B)</sub>		-	100	mA
I <sub>GND</sub>	ground current			-100	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[4]	-	250	mW

[1] The minimum input voltage rating and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2]  $V_{CCO}$  is the supply voltage associated with the output port.

[3]  $V_{CCO}$  + 0.5 V should not exceed 4.6 V.

[4] For SOT765-1 (VSSOP8) package: P<sub>tot</sub> derates linearly with 4.9 mW/K above 99 °C.

For SOT833-1 (XSON8) package: Ptot derates linearly with 3.1 mW/K above 68 °C.

For SOT1116 (XSON8) package: Ptot derates linearly with 4.2 mW/K above 90 °C.

For SOT1203 (XSON8) package: P<sub>tot</sub> derates linearly with 3.6 mW/K above 81 °C.

## 9. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Мах	Unit
V <sub>CC(A)</sub>	supply voltage A		0.8	3.6	V
V <sub>CC(B)</sub>	supply voltage B		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode [1]	0	V <sub>cco</sub>	V
		Suspend or 3-state mode	0	3.6	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CCI</sub> = 0.8 V to 3.6 V	-	5	ns/V

[1]  $V_{CCO}$  is the supply voltage associated with the output port.

### **10. Static characteristics**

#### Table 7. Typical static characteristics at T<sub>amb</sub> = 25 °C

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). [1][2]

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}; I_{O} = -1.5 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.69	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}; I_{O} = 1.5 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.07	-	V
I <sub>I</sub>	input leakage current	DIR input; $V_I = 0 V \text{ or } 3.6 V$ ; $V_{CC(A)} = V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	±0.025	±0.25	μA
I <sub>BHL</sub>	bus hold LOW current	$V_{I} = 0.42 \text{ V}; V_{CC(A)} = V_{CC(B)} = 1.2 \text{ V}$	8] -	26	-	μA
I <sub>BHH</sub>	bus hold HIGH current	$V_{I} = 0.78 V; V_{CC(A)} = V_{CC(B)} = 1.2 V$ [2	l] -	-24	-	μA
I <sub>BHLO</sub>	bus hold LOW overdrive current	$V_{I} = GND \text{ to } V_{CCI}; V_{CC(A)} = V_{CC(B)} = 1.2 \text{ V}$ [6	5] -	28	-	μA
I <sub>BHHO</sub>	bus hold HIGH overdrive current	$V_{I} = GND \text{ to } V_{CCI}; V_{CC(A)} = V_{CC(B)} = 1.2 \text{ V}$ [6	5] -	-26	-	μA
I <sub>OZ</sub>	OFF-state output current	A or B port; $V_O = 0 V$ or $V_{CCO}$ ; $V_{CC(A)} = V_{CC(B)} = 0.8 V$ to 3.6 V	'] -	±0.5	±2.5	μA
I <sub>OFF</sub>	power-off leakage current	A port; V <sub>1</sub> or V <sub>0</sub> = 0 V to 3.6 V; V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±0.1	±1	μA
		B port; V <sub>1</sub> or V <sub>0</sub> = 0 V to 3.6 V; V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 0.8 V to 3.6 V	-	±0.1	±1	μA
CI	input capacitance	DIR input; $V_I = 0 V \text{ or } 3.3 V$ ; $V_{CC(A)} = V_{CC(B)} = 3.3 V$	-	1.0	-	pF
C <sub>I/O</sub>	input/output capacitance	A and B port; Suspend mode; $V_O = V_{CCO}$ or GND; $V_{CC(A)} = V_{CC(B)} = 3.3 \text{ V}$	-	4.0	-	pF

[1]  $V_{CCO}$  is the supply voltage associated with the output port.

[2] V<sub>CCI</sub> is the supply voltage associated with the data input port.

[3] The bus hold circuit can sink at least the minimum low sustaining current at  $V_{IL}$  max.

 $I_{\mathsf{BHL}}$  should be measured after lowering  $V_{\mathsf{I}}$  to GND and then raising it to  $V_{\mathsf{IL}}$  max.

[4] The bus hold circuit can source at least the minimum high sustaining current at  $V_{\text{IH}}\,\text{min}.$ 

 $I_{\text{BHH}}$  should be measured after raising  $V_{\text{I}}$  to  $V_{\text{CC}}$  and then lowering it to  $V_{\text{IH}}$  min.

[5] An external driver must source at least  $I_{BHLO}$  to switch this node from LOW to HIGH.

[6] An external driver must sink at least  $I_{BHHO}$  to switch this node from HIGH to LOW.

[7] For I/O ports, the parameter  $I_{OZ}$  includes the input leakage current.

### Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).[1][2]

Symbol	Parameter	Conditions	-40 °C t	o +85 °C	-40 °C to	Unit	
			Min	Max	Min	Max	
VIH	HIGH-level	data input					
	input voltage	V <sub>CCI</sub> = 0.8 V	0.70V <sub>CCI</sub>	-	0.70V <sub>CCI</sub>	-	V
		V <sub>CCI</sub> = 1.1 V to 1.95 V	0.65V <sub>CCI</sub>	-	0.65V <sub>CCI</sub>	-	V
		V <sub>CCI</sub> = 2.3 V to 2.7 V	1.6	-	1.6	-	V
		V <sub>CCI</sub> = 3.0 V to 3.6 V	2	-	2	-	V
		DIR input					
		V <sub>CC(A)</sub> = 0.8 V	0.70V <sub>CC(A)</sub>	-	0.70V <sub>CC(A)</sub>	-	V
		V <sub>CC(A)</sub> = 1.1 V to 1.95 V	0.65V <sub>CC(A)</sub>	-	0.65V <sub>CC(A)</sub>	-	V
		V <sub>CC(A)</sub> = 2.3 V to 2.7 V	1.6	-	1.6	-	V
		V <sub>CC(A)</sub> = 3.0 V to 3.6 V	2	-	2	-	V
V <sub>IL</sub>	LOW-level	data input					
	input voltage	V <sub>CCI</sub> = 0.8 V	-	0.30V <sub>CCI</sub>	-	0.30V <sub>CCI</sub>	V
		V <sub>CCI</sub> = 1.1 V to 1.95 V	-	0.35V <sub>CCI</sub>	-	0.35V <sub>CCI</sub>	V
		V <sub>CCI</sub> = 2.3 V to 2.7 V	-	0.7	-	0.7	V
		V <sub>CCI</sub> = 3.0 V to 3.6 V	-	0.9	-	0.9	V
		DIR input					
		V <sub>CC(A)</sub> = 0.8 V	-	0.30V <sub>CC(A)</sub>	-	0.30V <sub>CC(A)</sub>	V
		V <sub>CC(A)</sub> = 1.1 V to 1.95 V	-	0.35V <sub>CC(A)</sub>		0.35V <sub>CC(A)</sub>	
		V <sub>CC(A)</sub> = 2.3 V to 2.7 V	-	0.7	-	0.7	V
		V <sub>CC(A)</sub> = 3.0 V to 3.6 V	-	0.9	-	0.9	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$					
		I <sub>O</sub> = -100 μA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 0.8 V to 3.6 V	V <sub>CCO</sub> - 0.1	-	V <sub>CCO</sub> - 0.1	-	V
		I <sub>O</sub> = -3 mA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.1 V	0.85	-	0.85	-	V
		I <sub>O</sub> = -6 mA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.4 V	1.05	-	1.05	-	V
		I <sub>O</sub> = -8 mA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.65 V	1.2	-	1.2	-	V
		$I_{O}$ = -9 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 2.3 V	1.75	-	1.75	-	V
		I <sub>O</sub> = -12 mA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 3.0 V	2.3	-	2.3	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$					
	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	0.1	-	0.1	V
		$I_{O} = 3 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.1 \text{ V}$	-	0.25	-	0.25	V
		$I_{O} = 6 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$	-	0.35	-	0.35	V
		I <sub>O</sub> = 8 mA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.65 V	-	0.45	-	0.45	V
		$I_{O}$ = 9 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 2.3 V	-	0.55	-	0.55	V
		$I_{O}$ = 12 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 3.0 V	-	0.7	-	0.7	V
1	input leakage current	DIR input; $V_I = 0 V \text{ or } 3.6 V$ ; $V_{CC(A)} = V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	±1	-	±1.5	μA

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#### Dual-bit, dual-supply voltage level translator/transceiver; 3-state

Symbol	Parameter	Conditions	-40 °C t	o +85 °C	-40 °C to	Unit	
		-	Min	Max	Min	Max	
I <sub>BHL</sub>	bus hold LOW	A or B port [3]					
	current	V <sub>I</sub> = 0.49 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.4 V	15	-	15	-	μA
		V <sub>I</sub> = 0.58 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.65 V	25	-	25	-	μA
		V <sub>I</sub> = 0.70 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 2.3 V	45	-	45	-	μA
		$V_{I} = 0.80 \text{ V}; V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	100	-	90	-	μA
I <sub>BHH</sub>	bus hold	A or B port [4]					
	HIGH current	V <sub>I</sub> = 0.91 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.4 V	-15	-	-15	-	μA
		V <sub>I</sub> = 1.07 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.65 V	-25	-	-25	-	μA
		V <sub>I</sub> = 1.60 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 2.3 V	-45	-	-45	-	μA
		$V_{I} = 2.00 \text{ V}; V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	-100	-	-100	-	μA
I <sub>BHLO</sub>	bus hold LOW	A or B port [5]					
	overdrive current	$V_{CC(A)} = V_{CC(B)} = 1.6 V$	125	-	125	-	μA
Cui	Guirein	$V_{CC(A)} = V_{CC(B)} = 1.95 V$	200	-	200	-	μA
		$V_{CC(A)} = V_{CC(B)} = 2.7 V$	300	-	300	-	μA
		$V_{CC(A)} = V_{CC(B)} = 3.6 V$	500	-	500	-	μA
I <sub>BHHO</sub>	bus hold	A or B port [6]					
	HIGH overdrive	$V_{CC(A)} = V_{CC(B)} = 1.6 V$	-125	-	-125	-	μA
	current	$V_{CC(A)} = V_{CC(B)} = 1.95 V$	-200	-	-200	-	μA
		$V_{CC(A)} = V_{CC(B)} = 2.7 V$	-300	-	-300	-	μA
		$V_{CC(A)} = V_{CC(B)} = 3.6 V$	-500	-	-500	-	μA
I <sub>OZ</sub>	OFF-state output current	A or B port; $V_O = 0 V$ or $V_{CCO}$ ; [7] $V_{CC(A)} = V_{CC(B)} = 0.8$ to 3.6 V	-	±5	-	±7.5	μA
I <sub>OFF</sub>	power-off leakage	A port; V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±5	-	±35	μA
	current	B port; V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 0.8 V to 3.6 V	-	±5	-	±35	μA
I <sub>CC</sub>	supply current	A port; $V_I = 0 V$ or $V_{CCI}$ ; $I_O = 0 A$					
		$V_{CC(A)} = 0.8 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 0.8 \text{ V to } 3.6 \text{ V}$	-	8	-	11.5	μA
		V <sub>CC(A)</sub> = 3.6 V; V <sub>CC(B)</sub> = 0 V	-	8	-	11.5	μA
		V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 3.6 V	-2	-	-8	-	μA
		B port; $V_I = 0 V$ or $V_{CCI}$ ; $I_O = 0 A$					
		$V_{CC(A)} = 0.8 V \text{ to } 3.6 V;$ $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	8	-	11.5	μA
		$V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$	-2	-	-8	-	μA
		V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 3.6 V	-	8	-	11.5	μA
		A plus B port ( $I_{CC(A)} + I_{CC(B)}$ ); $I_{O} = 0 A$ ; $V_{I} = 0 V \text{ or } V_{CCI}$ ; $V_{CC(A)} = 0.8 V \text{ to } 3.6 V$ ; $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$	-	16	-	23	μΑ

[1]  $V_{CCO}$  is the supply voltage associated with the output port.

[2]

 $V_{CCI}$  is the supply voltage associated with the data input port. The bus hold circuit can sink at least the minimum low sustaining current at  $V_{\rm IL}$  max. [3]

 $I_{\text{BHL}}$  should be measured after lowering  $V_{\text{I}}$  to GND and then raising it to  $V_{\text{IL}}$  max.

The bus hold circuit can source at least the minimum high sustaining current at VIH min. [4]

- $I_{BHH}$  should be measured after raising  $V_{\rm I}$  to  $V_{CC}$  and then lowering it to  $V_{\rm IH}$  min.
- [5] An external driver must source at least  $I_{BHLO}$  to switch this node from LOW to HIGH.
- [6] An external driver must sink at least I<sub>BHHO</sub> to switch this node from HIGH to LOW.

[7] For I/O ports, the parameter  $I_{OZ}$  includes the input leakage current.

# **11. Dynamic characteristics**

#### Table 9. Typical dynamic characteristics at $V_{CC(A)}$ = 0.8 V and $T_{amb}$ = 25 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5; for waveforms see Fig. 3 and Fig. 4. [1] [2]

Symbol	Parameter	Conditions		V <sub>CC(B)</sub>						
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V		
t <sub>pd</sub>	propagation delay	A to B	15.8	8.4	8.0	8.0	8.7	9.5	ns	
		B to A	15.8	12.7	12.4	12.2	12.0	11.8	ns	
t <sub>dis</sub>	disable time	DIR to A	12.2	12.2	12.2	12.2	12.2	12.2	ns	
		DIR to B	11.7	7.9	7.6	8.2	8.7	10.2	ns	
t <sub>en</sub>	enable time	DIR to A	27.5	20.6	20.0	20.4	20.7	22.0	ns	
		DIR to B	28.0	20.6	20.2	20.2	20.9	21.7	ns	

[1] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>; t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>; t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.

[2] t<sub>en</sub> is a calculated value using the formula shown in <u>Section 12.4</u>

#### Table 10. Typical dynamic characteristics at $V_{CC(B)}$ = 0.8 V and $T_{amb}$ = 25 $^{\circ}C$

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5; for waveforms see Fig. 3 and Fig. 4. [1] [2]

Symbol         Parameter         Conditions         V <sub>CC(A)</sub>								Unit	
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t <sub>pd</sub>	propagation delay	A to B	15.8	12.7	12.4	12.2	12.0	11.8	ns
		B to A	15.8	8.4	8.0	8.0	8.7	9.5	ns
t <sub>dis</sub>	disable time	DIR to A	12.2	4.9	3.8	3.7	2.8	3.4	ns
		DIR to B	11.7	9.2	9.0	8.8	8.7	8.6	ns
t <sub>en</sub>	enable time	DIR to A	27.5	17.6	17.0	16.8	17.4	18.1	ns
		DIR to B	28.0	17.6	16.2	15.9	14.8	15.2	ns

[1] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>; t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>; t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.

[2] t<sub>en</sub> is a calculated value using the formula shown in <u>Section 12.4</u>

#### Table 11. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \text{ °C}$ Voltages are referenced to GND (ground = 0 V).[1] [2]

Symbol	Parameter	Conditions	$V_{CC(A)}$ and $V_{CC(B)}$						Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
C <sub>PD</sub>	power dissipation capacitance	A port: (direction A to B); B port: (direction B to A)	1	2	2	2	2	2	pF
		A port: (direction B to A); B port: (direction A to B)	9	11	11	12	14	17	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>L</sub> = load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

[2]  $f_i = 10 \text{ MHz}$ ;  $V_I = \text{GND}$  to  $V_{CC}$ ;  $t_r = t_f = 1 \text{ ns}$ ;  $C_L = 0 \text{ pF}$ ;  $R_L = \infty \Omega$ .

#### Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5; for waveforms see Fig. 3 and Fig. 4. [1][2]

Symbol	Parameter	Conditions	V <sub>CC(B)</sub>								Unit		
			1.2 V :	± 0.1 V	1.5 V :	± 0.1 V	1.8 V ±	: 0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	1
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	-
$V_{CC(A)} =$	1.1 V to 1.3 V			1		1	1	1		1	<u> </u>	1	1
t <sub>pd</sub>	propagation	A to B	1.0	9.0	0.7	6.8	0.6	6.1	0.5	5.7	0.5	6.1	ns
	delay	B to A	1.0	9.0	0.8	8.0	0.7	7.7	0.6	7.2	0.5	7.1	ns
t <sub>dis</sub>	disable time	DIR to A	2.2	8.8	2.2	8.8	2.2	8.8	2.2	8.8	2.2	8.8	ns
		DIR to B	2.2	8.4	1.8	6.7	2.0	6.9	1.7	6.2	2.4	7.2	ns
t <sub>en</sub>	enable time	DIR to A	-	17.4	-	14.7	-	14.6	-	13.4	-	14.3	ns
		DIR to B	-	17.8	-	15.6	-	14.9	-	14.5	-	14.9	ns
V <sub>CC(A)</sub> =	1.4 V to 1.6 V												
t <sub>pd</sub>	propagation	A to B	1.0	8.0	0.7	5.4	0.6	4.6	0.5	3.7	0.5	3.5	ns
	delay	B to A	1.0	6.8	0.8	5.4	0.7	5.1	0.6	4.7	0.5	4.5	ns
t <sub>dis</sub>	disable time	DIR to A	1.6	6.3	1.6	6.3	1.6	6.3	1.6	6.3	1.6	6.3	ns
		DIR to B	2.0	7.6	1.8	5.9	1.6	6.0	1.2	4.8	1.7	5.5	ns
t <sub>en</sub>	enable time	DIR to A	-	14.4	-	11.3	-	11.1	-	9.5	-	10.0	ns
		DIR to B	-	14.3	-	11.7	-	10.9	-	10.0	-	9.8	ns
V <sub>CC(A)</sub> =	1.65 V to 1.95	V											
t <sub>pd</sub>	propagation	A to B	1.0	7.7	0.6	5.1	0.5	4.3	0.5	3.4	0.5	3.1	ns
	delay	B to A	1.0	6.1	0.7	4.6	0.5	4.4	0.5	3.9	0.5	3.7	ns
t <sub>dis</sub>	disable time	DIR to A	1.6	5.5	1.6	5.5	1.6	5.5	1.6	5.5	1.6	5.5	ns
		DIR to B	1.8	7.8	1.8	5.7	1.4	5.8	1.0	4.5	1.5	5.2	ns
t <sub>en</sub>	enable time	DIR to A	-	13.9	-	10.3	-	10.2	-	8.4	-	8.9	ns
		DIR to B	-	13.2	-	10.6	-	9.8	-	8.9	-	8.6	ns
V <sub>CC(A)</sub> =	2.3 V to 2.7 V												
t <sub>pd</sub>	propagation	A to B	1.0	7.2	0.5	4.7	0.5	3.9	0.5	3.0	0.5	2.6	ns
	delay	B to A	1.0	5.7	0.6	3.8	0.5	3.4	0.5	3.0	0.5	2.8	ns
t <sub>dis</sub>	disable time	DIR to A	1.5	4.2	1.5	4.2	1.5	4.2	1.5	4.2	1.5	4.2	ns
		DIR to B	1.7	7.3	2.0	5.2	1.5	5.1	0.6	4.2	1.1	4.8	ns
t <sub>en</sub>	enable time	DIR to A	-	13.0	-	9.0	-	8.5	-	7.2	-	7.6	ns
		DIR to B	-	11.4	-	8.9	-	8.1	-	7.2	-	6.8	ns
V <sub>CC(A)</sub> =	3.0 V to 3.6 V												
t <sub>pd</sub>	propagation	A to B	1.0	7.1	0.5	4.5	0.5	3.7	0.5	2.8	0.5	2.4	ns
	delay	B to A	1.0	6.1	0.6	3.6	0.5	3.1	0.5	2.6	0.5	2.4	ns
t <sub>dis</sub>	disable time	DIR to A	1.5	4.7	1.5	4.7	1.5	4.7	1.5	4.7	1.5	4.7	ns
		DIR to B	1.7	7.2	0.7	5.5	0.6	5.5	0.7	4.1	1.7	4.7	ns
t <sub>en</sub>	enable time	DIR to A	-	13.3	-	9.1	-	8.6	-	6.7	-	7.1	ns
		DIR to B	-	11.8	-	9.2	-	8.4	-	7.5	-	7.1	ns

#### Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5; for waveforms see Fig. 3 and Fig. 4. [1] [2]

Symbol	Parameter	Conditions			V <sub>CC(B)</sub>								Unit
		-	1.2 V ±0.1 V		1.5 V :	± 0.1 V	1.8 V ± 0.15 V		2.5 V	± 0.2 V	3.3 V :	± 0.3 V	1
			Min	Max	Min	Max	Min	Max	Min	Мах	Min	Max	-
V <sub>CC(A)</sub> =	1.1 V to 1.3 V										1	1	
t <sub>pd</sub>	propagation	A to B	1.0	9.9	0.7	7.5	0.6	6.8	0.5	6.3	0.5	6.8	ns
	delay	B to A	1.0	9.9	0.8	8.8	0.7	8.5	0.6	8.0	0.5	7.9	ns
t <sub>dis</sub>	disable time	DIR to A	2.2	9.7	2.2	9.7	2.2	9.7	2.2	9.7	2.2	9.7	ns
		DIR to B	2.2	9.2	1.8	7.4	2.0	7.6	1.7	6.9	2.4	8.0	ns
t <sub>en</sub>	enable time	DIR to A	-	19.1	-	16.2	-	16.1	-	14.9	-	15.9	ns
		DIR to B	-	19.6	-	17.2	-	16.5	-	16.0	-	16.5	ns
V <sub>CC(A)</sub> =	1.4 V to 1.6 V						·						
t <sub>pd</sub>	propagation	A to B	1.0	8.8	0.7	6.0	0.6	5.1	0.5	4.1	0.5	3.9	ns
	delay	B to A	1.0	7.5	0.8	6.0	0.7	5.7	0.6	5.2	0.5	5.0	ns
t <sub>dis</sub>	disable time	DIR to A	1.6	7.0	1.6	7.0	1.6	7.0	1.6	7.0	1.6	7.0	ns
		DIR to B	2.0	8.3	1.8	6.5	1.6	6.6	1.2	5.3	1.7	6.1	ns
t <sub>en</sub>	enable time	DIR to A	-	15.8	-	12.5	-	12.3	-	10.5	-	11.1	ns
		DIR to B	-	15.8	-	13.0	-	12.7	-	11.1	-	10.9	ns
V <sub>CC(A)</sub> =	1.65 V to 1.95	V											
t <sub>pd</sub>	propagation	A to B	1.0	8.5	0.6	5.7	0.5	4.8	0.5	3.8	0.5	3.5	ns
	delay	B to A	1.0	6.8	0.7	5.1	0.5	4.9	0.5	4.3	0.5	4.1	ns
t <sub>dis</sub>	disable time	DIR to A	1.6	6.1	1.6	6.1	1.6	6.1	1.6	6.1	1.6	6.1	ns
		DIR to B	1.8	8.6	1.8	6.3	1.4	6.4	1.0	5.0	1.5	5.8	ns
t <sub>en</sub>	enable time	DIR to A	-	15.4	-	11.4	-	11.3	-	9.3	-	9.9	ns
		DIR to B	-	14.6	-	11.8	-	10.9	-	9.9	-	9.6	ns
V <sub>CC(A)</sub> =	2.3 V to 2.7 V			1									
t <sub>pd</sub>	propagation	A to B	1.0	8.0	0.5	5.2	0.5	4.3	0.5	3.3	0.5	2.9	ns
	delay	B to A	1.0	6.3	0.6	4.2	0.5	3.8	0.5	3.3	0.5	3.1	ns
t <sub>dis</sub>	disable time	DIR to A	1.5	4.7	1.5	4.7	1.5	4.7	1.5	4.7	1.5	4.7	ns
		DIR to B	1.7	8.0	2.0	5.8	1.5	5.7	0.6	4.7	1.1	5.3	ns
t <sub>en</sub>	enable time	DIR to A	-	14.3	-	10.0	-	9.5	-	8.0	-	8.4	ns
		DIR to B	-	12.7	-	9.9	-	9.0	-	8.0	-	7.6	ns
. ,	3.0 V to 3.6 V			1	1			1		1	1	1	
t <sub>pd</sub>	propagation delay	A to B	1.0	7.9	0.5	5.0	0.5	4.1	0.5	3.1	0.5	2.7	ns
	-	B to A	1.0	6.8	0.6	4.0	0.5	3.5	0.5	2.9	0.5	2.7	ns
t <sub>dis</sub>	disable time	DIR to A	1.5	5.2	1.5	5.2	1.5	5.2	1.5	5.2	1.5	5.2	ns
		DIR to B	1.7	7.9	0.7	6.1	0.6	6.1	0.7	4.6	1.7	5.2	ns
t <sub>en</sub>	enable time	DIR to A	-	14.7	-	10.1	-	9.6	-	7.5	-	7.9	ns
		DIR to B	-	13.1	-	10.2	-	9.3	-	8.3	-	7.9	ns

### 11.1. Waveforms and test circuit

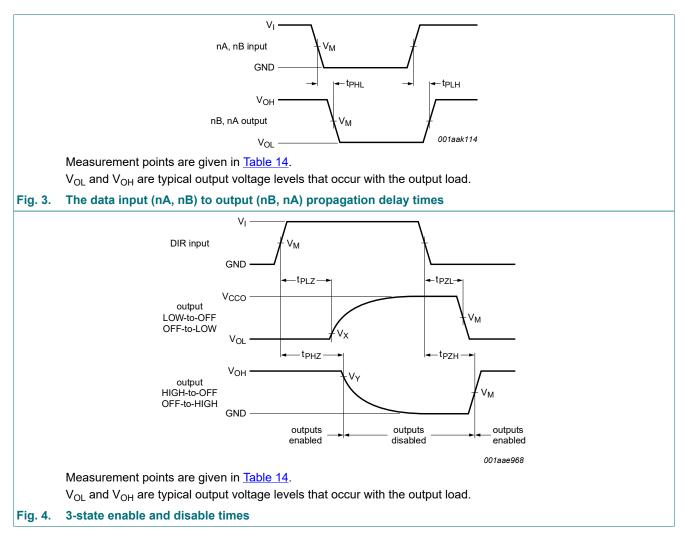


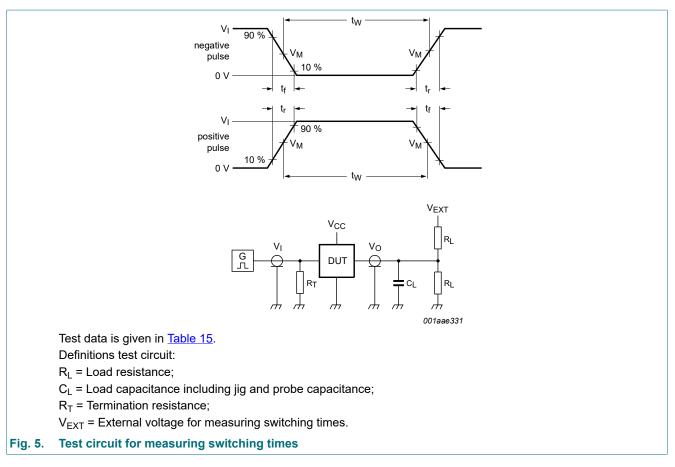
Table 14. Measurem	nent points			
Supply voltage	Input[1]	Output[2]		
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
1.1 V to 1.6 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.1 V	V <sub>OH</sub> - 0.1 V
1.65 V to 2.7 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V
3.0 V to 3.6 V	0.5V <sub>CCI</sub>	0.5V <sub>CCO</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V

[1]  $V_{CCI}$  is the supply voltage associated with the data input port.

[2]  $V_{CCO}$  is the supply voltage associated with the output port.

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#### Table 15. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>			
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	V <sub>I</sub> [1]	Δt/ΔV [2]	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub> [3]	
1.1 V to 1.6 V	V <sub>CCI</sub>	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>	
1.65 V to 2.7 V	V <sub>CCI</sub>	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>	
3.0 V to 3.6 V	V <sub>CCI</sub>	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	2V <sub>CCO</sub>	

[1]  $V_{CCI}$  is the supply voltage associated with the data input port.

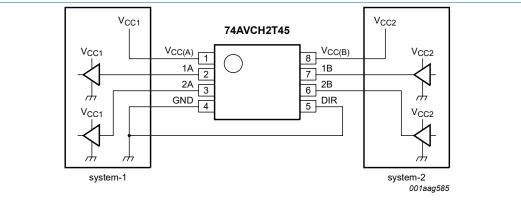
[2] dV/dt ≥ 1.0 V/ns

[3]  $V_{CCO}$  is the supply voltage associated with the output port.

## **12.** Application information

### 12.1. Unidirectional logic level-shifting application

The circuit given in Fig. 6 is an example of the 74AVCH2T45 being used in an unidirectional logic level-shifting application.



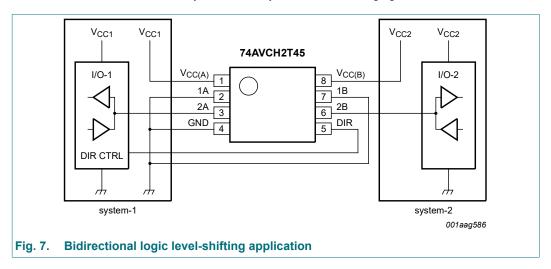
#### Fig. 6. Unidirectional logic level-shifting application

#### Table 16. Unidirectional logic level-shifting application

Pin	Name	Function	Description
1	V <sub>CC(A)</sub>	V <sub>CC1</sub>	supply voltage of system-1 (0.8 V to 3.6 V)
2	1A	OUT1	output level depends on V <sub>CC1</sub> voltage
3	2A	OUT2	output level depends on V <sub>CC1</sub> voltage
4	GND	GND	device GND
5	DIR	DIR	the GND (LOW level) determines B port to A port direction
6	2B	IN2	input threshold value depends on V <sub>CC2</sub> voltage
7	1B	IN1	input threshold value depends on V <sub>CC2</sub> voltage
8	V <sub>CC(B)</sub>	V <sub>CC2</sub>	supply voltage of system-2 (0.8 V to 3.6 V)

### 12.2. Bidirectional logic level-shifting application

Fig. 7 shows the 74AVCH2T45 being used in a bidirectional logic level-shifting application. Since the device does not have an output enable (OE) pin, the system designer should take precautions to avoid bus contention between system-1 and system-2 when changing directions.



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<u>Table 17</u> gives a sequence that will illustrate data transmission from system-1 to system-2 and then from system-2 to system-1.

State	DIR CTRL	I/O-1	I/O-2	Description
1	Н	output	input	system-1 data to system-2
2	Н	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold.
3	L	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 still are disabled. The bus-line state depends on bus hold.
4	L	input	output	system-2 data to system-1

#### Table 17. Bidirectional logic level-shifting application [1]

[1] H = HIGH voltage level;

L = LOW voltage level;

Z = high-impedance OFF-state.

### 12.3. Power-up considerations

The device is designed such that no special power-up sequence is required other than GND being applied first.

V <sub>CC(A)</sub>				V <sub>CC(B)</sub>				Unit
	0 V	0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
0 V	0	0.1	0.1	0.1	0.1	0.1	0.1	μA
0.8 V	0.1	0.1	0.1	0.1	0.1	0.7	2.3	μA
1.2 V	0.1	0.1	0.1	0.1	0.1	0.3	1.4	μA
1.5 V	0.1	0.1	0.1	0.1	0.1	0.1	0.9	μA
1.8 V	0.1	0.1	0.1	0.1	0.1	0.1	0.5	μA
2.5 V	0.1	0.7	0.3	0.1	0.1	0.1	0.1	μA
3.3 V	0.1	2.3	1.4	0.9	0.5	0.1	0.1	μA

### Table 18. Typical total supply current (I<sub>CC(A)</sub> + I<sub>CC(B)</sub>)

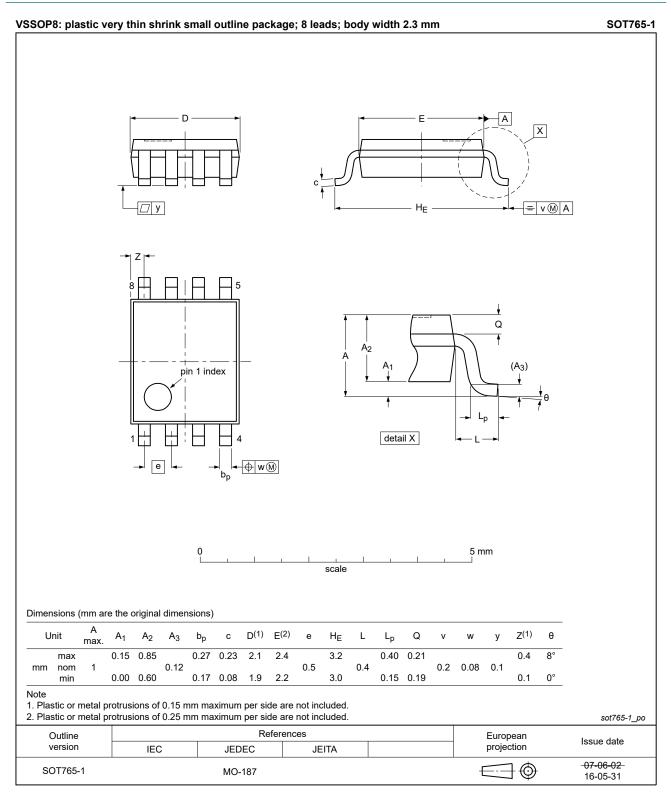
### 12.4. Enable times

The enable times for the 74AVCH2T45 are calculated from the following formulas:

- $t_{en}$  (DIR to nA) =  $t_{dis}$  (DIR to nB) +  $t_{pd}$  (nB to nA)
- $t_{en}$  (DIR to nB) =  $t_{dis}$  (DIR to nA) +  $t_{pd}$  (nA to nB)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the 74AVCH2T45 initially is transmitting from A to B, then the DIR bit is switched, the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

# 13. Package outline



#### Fig. 8. Package outline SOT765-1 (VSSOP8)

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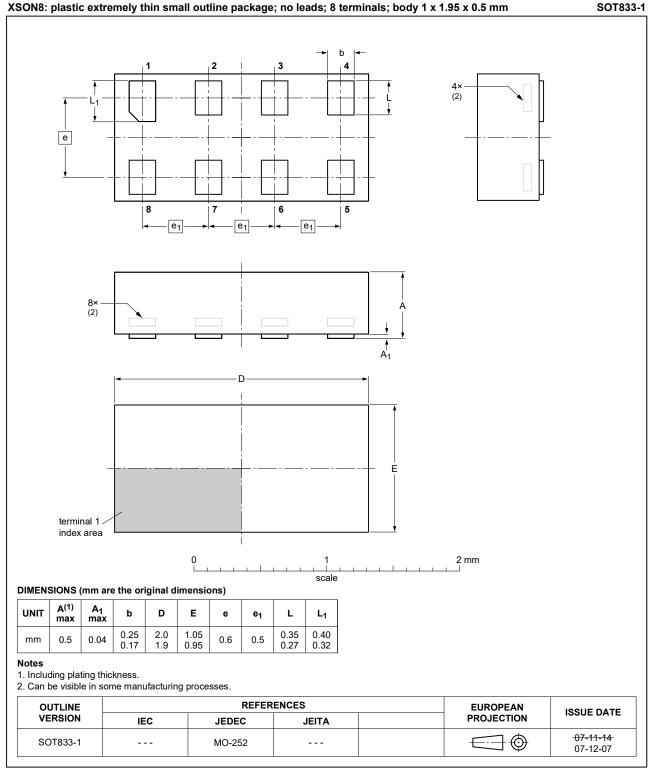
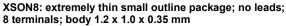


Fig. 9. Package outline SOT833-1 (XSON8)



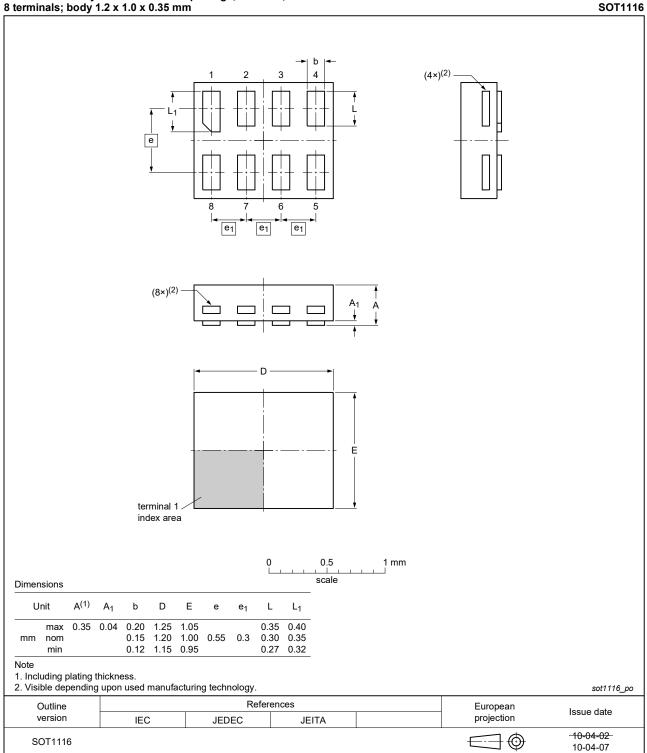
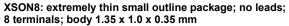
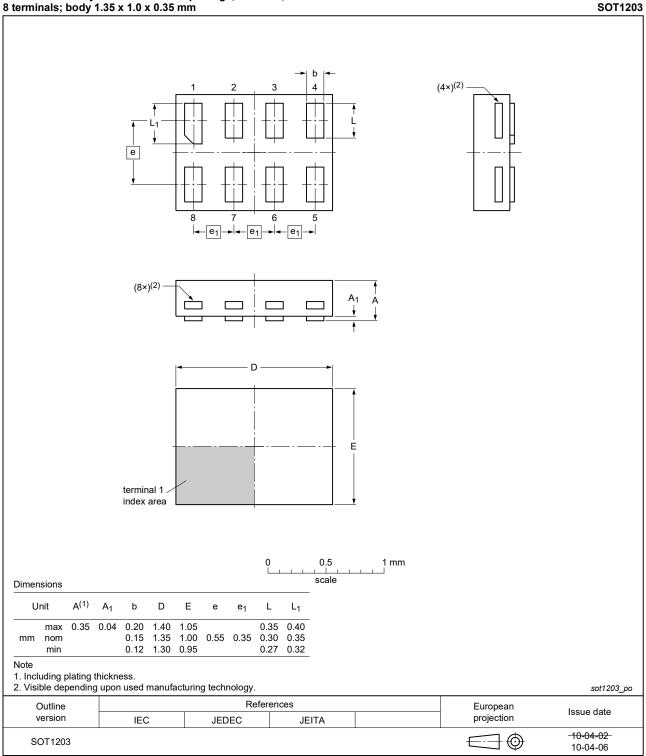


Fig. 10. Package outline SOT1116 (XSON8)







# 14. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
НВМ	Human Body Model
JEDEC	Joint Electron Device Engineering Council

## 15. Revision history

Table 20. Revision histo	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74AVCH2T45 v.9	20240625	Product data sheet	-	74AVCH2T45 v.8
Modifications:	Type numb	per 74AVCH2T45GF (SC	T1089/XSON8) rem	oved.
74AVCH2T45 v.8	20221207	Product data sheet	-	74AVCH2T45 v.7
Modifications:	<ul> <li><u>Section 2</u> u</li> <li><u>Table 5</u>: De</li> </ul>	updated. erating values for P <sub>tot</sub> tot	al power dissipation	updated.
74AVCH2T45 v.7	20180220	Product data sheet	-	74AVCH2T45 v.6
Modifications: 74AVCH2T45 v.6	guidelines <ul> <li>Legal texts</li> </ul>	t of this data sheet has b of Nexperia. have been adapted to t type number 74AVCH2T Product data sheet	he new company nar	ne where appropriate.
Modifications:	For type ni	umber 74AVCH2T45GD	XSON8U has chang	ed to XSON8.
74AVCH2T45 v.5	20111214	Product data sheet	-	74AVCH2T45 v.4
Modifications:	Legal page	es updated.		
74AVCH2T45 v.4	20101124	Product data sheet	-	74AVCH2T45 v.3
74AVCH2T45 v.3	20090506	Product data sheet	-	74AVCH2T45 v.2
74AVCH2T45 v.2	20090203	Product data sheet	-	74AVCH2T45 v.1
74AVCH2T45 v.1	20070703	Product data sheet	-	-

# 16. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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